

C0603C159CATAC7411

SMD Comm X8G HT150C, Ceramic, 1.5 pF, +/-0.25 pF, 250 VDC, X8G, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.5 mm



Click here for the 3D model.

General Information	
Series	SMD Comm X8G HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	3.7 mg
Shelf Life	78 Weeks
MSL	1

	Specifications	
0603	Capacitance	1.5 pF
1.6mm +/-0.15mm	Measurement Condition	1 MHz 1.0Vrms
0.8mm +/-0.15mm	Tolerance	+/-0.25 pF
0.8mm +/-0.07mm	Voltage DC	250 VDC
0.5mm MIN	Dielectric Withstanding Voltage	625 VDC
0.35mm +/-0.15mm	Temperature Range	-55/+150°C
	Temp. Coefficient	X8G
T&R, 330mm, Paper Tape	Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
15000	Dissipation Factor	0.1% 1 MHz 1.0Vrms

Aging Rate

Insulation Resistance

 W
 0.8mm +/-0.15mm

 T
 0.8mm +/-0.07mm

 S
 0.5mm MIN

 B
 0.35mm +/-0.15mm

Packaging SpecificationsPackagingT&R, 330mm, Paper TaPackaging Quantity15000

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute – and we specifically disclaim – any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

Dimensions Chip Size

L

0% Loss/Decade Hour: Referee

Time is 1000 Hours

100 GOhms